

2:1 MIPI D-PHY (2.5 Gbps) 4-Data Lane & C-PHY (2.5 Gsps) 3-Data Lane **Switch**

FSA646

Description

The FSA646 is a four-data-lane D-PHY or three-data-lane C-PHY, MIPI switch. This single-pole, double-throw (SPDT) switch is optimized for switching between two high-speed or low-power MIPI sources. The FSA646 is designed for the MIPI specification and allows connection to a SCI or DSI module.

Features

- Switch Type: SPDT (10x)
- Signal Types:
 - ♦ MIPI, D-PHY & C-PHY
- V_{CC}: 1.5 to 5.0 V
- Input Signals: 0 to 1.3 V
- R_{ON}:
 - 6 Ω Typical HS MIPI
 - 6 Ω Typical LP MIPI
- ΔR_{ON} : 0.1 Ω Typical LP & HS MIPI
- $\Delta R_{ON\ FLAT}$: 0.9 Ω Typical LP & HS MIPI
- I_{CCZ}: 1 µA Maximum
- I_{CC}: 32 μA Typical
- O_{IRR}: -24 dB Typical
- Bandwidth: 4.1 GHz Typical
- Xtalk: -30 dB Typical
- C_{ON}: 1.5 pF Typical
- Skew (P), Skew (O): 6 ps Typical
- This is a Pb-Free Device

Applications

- Cellular Phones, Smart Phones
- Tablets
- Laptops
- Displays



(Bottom View)

WLCSP36, 2.43x2.43x0.4 CASE 567WJ

MARKING DIAGRAM

GSKK XYZ J-PUU

= Specific Device Code

ΚK = Assembly Lot

X Y = Year

= Work Week

Ż = Assembly Location

= X- Coordinates with dash as separator*

= Y Coordinates*

= Two Digit Wafer ID*

*For onsemi internal use only.

ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

1

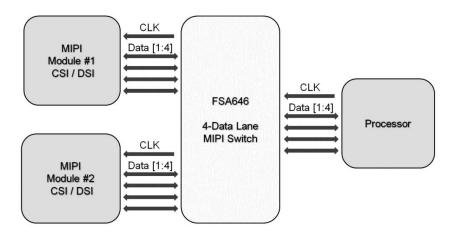


Figure 1. Typical D-PHY Application

PIN DESCRIPTIONS

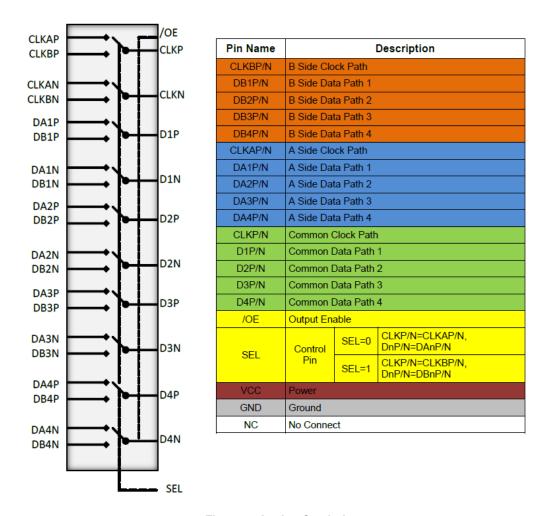


Figure 2. Analog Symbol

PIN DEFINITIONS

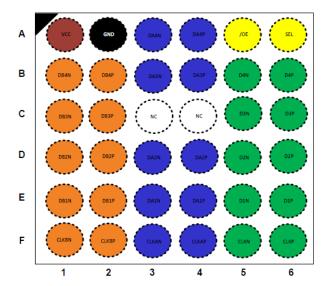


Figure 3. Top Through View

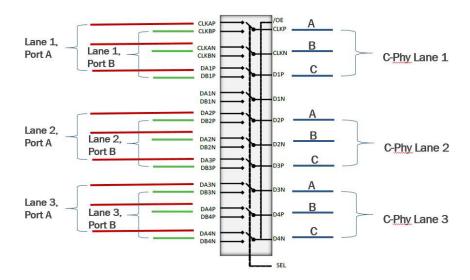


Figure 4. Recommended C-PHY Configuration

Table 1. BALL-TO-PIN MAPPINGS

Ball	Pin Name	Ball	Pin Name	Ball	Pin Name
A1	V _{CC}	C1	DB3N	E1	DB1N
A2	GND	C2	DB3P	E2	DB1P
A3	DA4N	СЗ	NC	E3	DA1N
A4	DA4P	C4	NC	E4	DA1P
A5	/OE	C5	D3N	E5	D1N
A6	SEL	C6	D3P	E6	D1P
B1	DB4N	D1	DB2N	F1	CLKBN
B2	DB4P	D2	DB2P	F2	CLKBP
В3	DA3N	D3	DA2N	F3	CLKAN
B4	DA3P	D4	DA2P	F4	CLKAP
B5	D4N	D5	D2N	F5	CLKN
B6	D4P	D6	D2P	F6	CLKP

TRUTH TABLE

SEL	/OE	Function
LOW	LOW	$CLK_P = CLKA_P$, $CLK_N = CLKA_N$, $Dn(P/N) = DAn(P/N)$
HIGH	LOW	$CLK_P = CLKB_P$, $CLK_N = CLKB_N$, $Dn(P/N) = DBn(P/N)$
X	HIGH	Clock and Data Ports High Impedance

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Min.	Max.	Unit
V _{CC}	Supply Voltage		-0.5	6.0	V
V _{CNTRL}	DC Input Voltage (/OE, SEL)	(Note 1)	-0.5	V _{CC}	V
V_{SW}	DC Switch I/O Voltage	(Note 1,2)	-0.3	1.8	V
I _{IK}	DC Input Diode Current		-50		mA
I _{OUT}	DC Output Current			25	mA
T _{STG}	Storage Temperature		-65	+150	°C
ESD	Human Body Model, JEDEC: JESD22-A114	All Pins	2.0		kV
	Charged Device Model, JEDEC: JESD22-C101				
	IEC 61000-4-2 System Contact		8.0		1
		Air Gap	15.0		1

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter			Max.	Unit
V _{CC}	Supply Voltage		1.5	5.0	V
V _{CNTRL}	Control Input Voltage (SEL, /OE) (Note 3)		0	V _{CC}	V
V _{SW}	- · · · · · · · · · · · · · · · · · · ·	-HS Mode	0	0.3	V
	(CLKn, Dn, CLKAn, CLKBn, Dan, DBn)	-LS Mode	0	1.3	V
T _A	Operating Temperature		-40	+85	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

3. The control inputs must be held HIGH or LOW; they must no float.

The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.
 V_{SW} refers to analog data switch paths.

$\textbf{DC AND TRANSIENT CHARACTERISTICS} \ (T_{A} = 25^{\circ}C \ unless \ otherwise \ specified)$

				T _A =	-40 to +8	B5°C	
Symbol	Parameter	Conditions	V _{CC} (V)	Min.	Тур.	Max.	Unit
V_{IK}	Clamp Diode Voltage (/OE, SEL)	I _{IN} = -18 mA	1.5	-1.2		-0.6	V
V _{IH}	Input Voltage High	SEL, /OE	1.5 to 5	1.3			V
V _{IL}	Input Voltage Low	SEL, /OE	1.5 to 5			0.5	V
I _{IN}	Control Input Leakage (/OE, SEL)	V _{CNTRL} = 0 to V _{CC}	5	-0.5		0.5	μΑ
I _{NO(OFF)} I _{NC(OFF)}	Off Leakage Current of Port CLKAn, Dan, CLKBn and DBn	V _{SW} = 0.0 ≤[DATA ≤ 1.3 V	5	-0.5		0.5	μΑ
I _{A(ON)}	ON Leakage Current of Common Ports (CLKn, Dn)	V _{SW} = 0.0 ≤[DATA ≤ 1.3 V	5	-0.5		0.5	μА
I _{OFF}	Power-Off Leakage Current (All I/O Ports)	V _{SW} = 0.0 or 1.3 V	0	-0.5		0.5	μΑ
l _{OZ}	Off-State Leakage	V _{SW} = 0.0 ≤[DATA ≤ 1.3 V /OE = High	5	-0.5		0.5	μΑ
R _{ON_MIPI_HS}	Switch On Resistance for	I _{ON} = -8 mA, /OE = 0 V,	1.5		6		Ω
	HS MIPI Applications (Note 4)	SEL = V_{CC} or 0 V, CLKA, CLKB, DB _N or DA _N = 0.2 V	2.5				
			3.3				
			5				
R _{ON_MIPI_LP}	Switch On Resistance for	I _{ON} = -8 mA, /OE = 0 V,	1.5		6		Ω
	LP MIPI Applications (Note 4)	SEL = V_{CC} or 0 V, CLKA, CLKB, DB _N or DA _N = 1.2 V	2.5				
			3.3				
			5				
$\Delta R_{ON_MIPI_HS}$	On Resistance Matching	I _{ON} = -8 mA, /OE = 0 V,	1.5		0.1		Ω
	Between HS MIPI Channels	$\overrightarrow{SEL} = V_{CC}$ or 0 V, CLKA, CLKB, $\overrightarrow{DB_N}$ or $\overrightarrow{DA_N} = 0.2 \text{ V}$	2.5				
	(Note 4)		3.3				
			5				
$\Delta R_{ON_MIPI_LP}$	On Resistance Matching	I _{ON} = -8 mA, /OE = 0 V,	1.5		0.1		Ω
	Between LP MIPI Channels	SEL = V_{CC} or 0 V, CLKA, CLKB, DB _N or DA _N = 1.2 V	2.5				
	(Note 4)		3.3				
			5				
R _{ON_FLAT_MIPI_HS}	On Resistance Flatness	I _{ON} = -8 mA, /OE = 0 V,	1.5		0.9		Ω
	for HS MIPI Signals (Note 4)	SEL = V_{CC} or 0 V, CLKA, CLKB, DB _N or DA _N = 0 to	2.5				
		0.3 V	3.3				
			5				
R _{ON_FLAT_MIPI_LP}	On Resistance Flatness	I _{ON} = -8 mA, /OE = 0 V,	1.5		0.9		Ω
	for LP MIPI Signals (Note 4)	SEL = V_{CC} or 0 V, CLKA, CLKB, DB _N or DA _N = 0 to	2.5				
		1.3 V	3.3				
			5				
I _{CC}	Quiescent Supply Current (Includes Change Pump)	V _{SEL} = 0 or V _{CC} , I _{OUT} = 0, /OE = 0 V	5			30	μΑ

$\textbf{DC AND TRANSIENT CHARACTERISTICS} \ (T_A = 25^{\circ}C \ unless \ otherwise \ specified) \ (continued)$

				T _A =	-40 to +8	35°C	
Symbol	Parameter	Conditions	V _{CC} (V)	Min.	Тур.	Max.	Unit
Iccz	Quiescent Supply Current (High Impedance)	V _{SEL} = 0 or V _{CC} , I _{OUT} = 0, /OE = 0 V	5			1	μΑ
Ісст	Increase in I _{CC} Current Per Control Voltage and V _{CC}	$V_{SEL} = 0$ or V_{CC} , $/OE = 1.5 V$	5		1		μΑ

^{4.} Measured by the voltage drop between A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltage on the two (A or B ports).

AC ELECTRICAL CHARACTERISTICS (V $_{CC}$ = 3.3 V and T $_{A}$ = 25 $^{\circ}C$ unless otherwise specified)

				$T_A = -40 \text{ to } +85^{\circ}\text{C}$		35°C	
Symbol	Parameter	Conditions	V _{CC} (V)	Min.	Тур.	Max.	Unit
t _{INIT}	Initialization Time V _{CC} to Output (Note 5)	$\begin{aligned} R_L &= 50 \ \Omega, \ C_L = 0 \ pF, \\ V_{SW} &= 0.6 \ V \end{aligned}$	1.5 to 5		60		μs
t _{EN}	Enable Time /OE to Output	$\begin{aligned} R_L &= 50~\Omega, C_L = 0~\text{pF}, \\ V_{SW} &= 0.6~\text{V} \end{aligned}$	1.5 to 5		60	150	μs
t _{DIS}	Disable Time /OE to Output	$\begin{aligned} R_L &= 50 \ \Omega, \ C_L = 0 \ \text{pF}, \\ V_{SW} &= 0.6 \ \text{V} \end{aligned}$	1.5 to 5		35	250	ns
t _{ON}	Turn-On Time SEL to Output	$\begin{aligned} R_L &= 50~\Omega, C_L = 0~\text{pF}, \\ V_{SW} &= 0.6~\text{V} \end{aligned}$	1.5 to 5		350	1100	ns
t _{OFF}	Turn-Off Time SEL to Output	$\begin{aligned} R_L &= 50 \ \Omega, \ C_L = 0 \ \text{pF}, \\ V_{SW} &= 0.6 \ \text{V} \end{aligned}$	1.5 to 5		125	800	ns
t _{BBM}	Break-Before-Make Time	$\begin{aligned} R_L &= 50~\Omega, C_L = 0~\text{pF}, \\ V_{SW} &= 0.6~\text{V} \end{aligned}$	1.5 to 5	50		450	ns
t _{PD}	Propagation Delay (Note 5)	C_L = 0 pF, R_L = 50 Ω	1.5 to 5	30	67	100	ps
O _{IRR}	Off Isolation for MIPI (Note 5)	R_L = 50 Ω , f = 1250 MHz, /OE = HIGH, V_{SW} = 0.2 V_{PP}	1.5 to 5		-24		dB
X _{TALK}	Crosstalk for MIPI (Note 5)	R_L = 50 Ω , f = 1250 MHz, SEL = High, V_{SW} = 0.2 V_{PP}	1.5 to 5		-30	-25	dB
		R_L = 50 Ω , f = 1250 MHz, SEL = Low, V_{SW} = 0.2 V_{PP}]		-30	-25	
BW	-3 db Bandwidth (Note 5)	$\begin{aligned} R_L &= 50 \ \Omega, \ C_L = 0 \ \text{pF}, \\ V_{SW} &= 0.2 \ V_{PP} \end{aligned}$	1.5 to 5	2.5	4.1		GHz
IL	Insertion Loss at 750 MHz (Note 5)	$\begin{aligned} R_L &= 50~\Omega, C_L = 0~\text{pF}, \\ V_{SW} &= 0.2~\text{V}_{PP} \end{aligned}$	1.5 to 5		-0.7		dB

^{5.} Guaranteed by characterization.

HIGH-SPEED-RELATED AC ELECTRICAL CHARACTERISTICS

				T _A =	T _A = -40 to +85°C		
Symbol	Parameter	Conditions	V _{CC} (V)	Min.	Тур.	Max.	Unit
t _{SK(P)}	HS Mode Skew of Opposite Transitions of the Same Output (Note 6)	$R_L = 50 \Omega$, $C_L = 0 pF$, $V_{SW} = 0.3 V$	1.5 to 5		6		ps
t _{SK(O)}	HS Mode Skew of Channel-to-Channel Single-Ended Skew (Note 6)	$R_L = 50 \Omega$, $C_L = 0 pF$, $V_{SW} = 0.3 V$	1.5 to 5		6		ps

^{6.} Guaranteed by characterization.

CAPACITANCE

			T _A =	-40 to +8	5°C	
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
C _{IN}	Control Pin Input Capacitance (Note 7)	V _{CC} = 0 V, f = 1 MHz		2.1		pF
C _{ON}	On Capacitance (Note 7)	V_{CC} = 3.3 V, /OE = 0 V, f = 1250 MHz (in HS common value)		1.5		
C _{OFF}	On Capacitance (Note 7)	V _{CC} and /OE = 3.3 V, f = 1250 MHz (both sides in HS common value)		0.9		

^{7.} Guaranteed by characterization.

The table below pertains to the Packaging information on the following page.

ORDERING INFORMATION

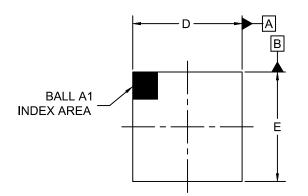
Part Number	Top Marking	Package	Top Mark
FSA646UCX	−40 to +85°C	36-Ball WLCSP, Non-JEDEC 2.43 x 2.43 mm, 0.4 mm Pitch	GS



WLCSP36 2.43x2.43x0.488

CASE 567WJ ISSUE A

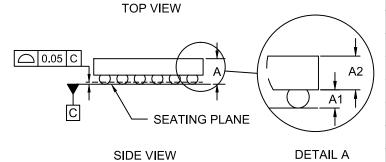
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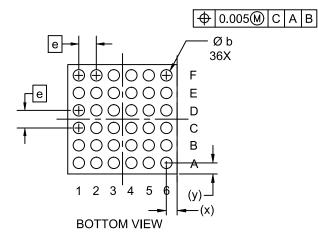


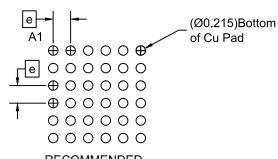
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DATUM C APPLIES TO THE SPHERICAL CROWN OF THE SOLDER BALLS

	MILLIMETERS					
DIM	MIN.	NOM.	MAX.			
Α	0.450	0.488	0.526			
A1	0.176	0.196	0.216			
A2	0.274	0.292	0.310			
b	0.240	0.260	0.280			
D	2.400	2.430	2.460			
E	2.400	2.430	2.460			
е		0.40 BSC				
х	0.200	0.215	0.230			
у	0.200	0.215	0.230			







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